

EAST Search History**EAST Search History (Prior Art)**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S84	3	"4001863".pn.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/21 10:36
S85	21	("2773158" "2839646" "3742599" "3764862" "3805375").PN. OR ("4001863").URPN.	US_PGPUB; USPAT; USOCR	ADJ	ON	2009/10/21 10:38
S89	4	(photodetector or (back near4 illuminate\$3)) and ((resin or coating) with chamfered)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/21 11:05
S90	1313	(photodetector or (back near4 illuminate\$3)) and ((resin or coating) with (chamfer\$3 or cut or edge))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/21 11:06
S91	22	(photodetector or (back near4 illuminate\$3)) and ((resin or coating) with (chamfer\$3 or cut near4 edge))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/21 11:06
S92	383	(photodetector or (back near4 illuminate\$3)or LED) and ((resin or coating) with (chamfer\$3 or cut near4 edge))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/21 11:08
S94	1	("2006/0191215").URPN.	USPAT	ADJ	ON	2009/10/21 13:13
S95	422	257/434.ccls.	USPAT	ADJ	ON	2009/10/21 13:43
S96	7	257/434.ccls. and (chamfer \$3 or cut near3 edge)	USPAT	ADJ	ON	2009/10/21 13:52

S97	11	(("20060102917" "20070047109" "20070158773" "20070189676" "4896217" "6663296" "6758611" "6791076" "6953291" "7226222" "7296939").PN. OR ((7420754).URPN.	US-PGPUB; USPAT; USOOR	ADJ	ON	2009/10/21 14:04
S98	2	"5691548".pn.	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/22 10:01
S99	27	257/434.cols. and ((chipp\$4 or crack\$4 or dic\$4 or cut\$4 or saw\$4 or separat\$4) with (preven\$4 or avoid\$4))	USPAT	ADJ	ON	2009/10/22 10:54
S100	22	LED and (resin or coat\$4) near4 expos\$4 same ((chipp\$4 or crack\$4 or dic\$4 or cut\$4 or saw\$4 or separat\$4) with (preven\$4 or avoid\$4))	USPAT	ADJ	ON	2009/10/22 11:12
S101	0	LED and (chamfer\$4 with (resin or coat\$4) near4 expos\$4)	USPAT	ADJ	ON	2009/10/22 11:17
S102	176	LED and ((chamfer\$4 or cut\$4 or edge) with (resin or coat\$4) near4 expos\$4)	USPAT	ADJ	ON	2009/10/22 11:17
S103	69	@rlad<"20030729" and S102	US-PGPUB; USPAT; USOOR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/22 11:18
S104	69	LED and chamfer\$4 same ((chipp\$4 or crack\$4 or dic\$4 or cut\$4 or saw\$4 or separat\$4) with (preven\$4 or avoid\$4))	USPAT	ADJ	ON	2009/10/22 11:22
S105	0	LED and (chamfer\$4 same ((coat\$4 or resin) near4 expose\$4)) and ((chipp\$4 or crack\$4 or dic\$4 or cut\$4 or saw\$4 or separat\$4) with (preven\$4 or avoid\$4))	USPAT	ADJ	ON	2009/10/22 11:42

S106	8	(chamfer\$4 same ((coat\$4 or resin) near4 expose\$4)) and ((chipp\$4 or crack\$4 or dic\$4 or cut\$4 or saw\$4 or separat\$4) with (preven\$4 or avoid\$4))	USPAT	ADJ	ON	2009/10/22 11:42
S107	1	"5691548".pn.	USPAT	ADJ	ON	2009/10/22 13:24
S108	2	"20010006461"	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/22 13:41
S109	3771	257/431.437,e27.133, e31.118.OCLS.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/23 11:27
S110	16	257/431.437,e27.133, e31.118.OCLS. and chamfer \$3	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/23 11:30
S111	2	coating near3 layer near5 exposed with chamfer\$3. clm.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/23 11:38
S112	8	recessed with outer near4 edge with semiconductor near4 substrate.clm.	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/10/23 11:40

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